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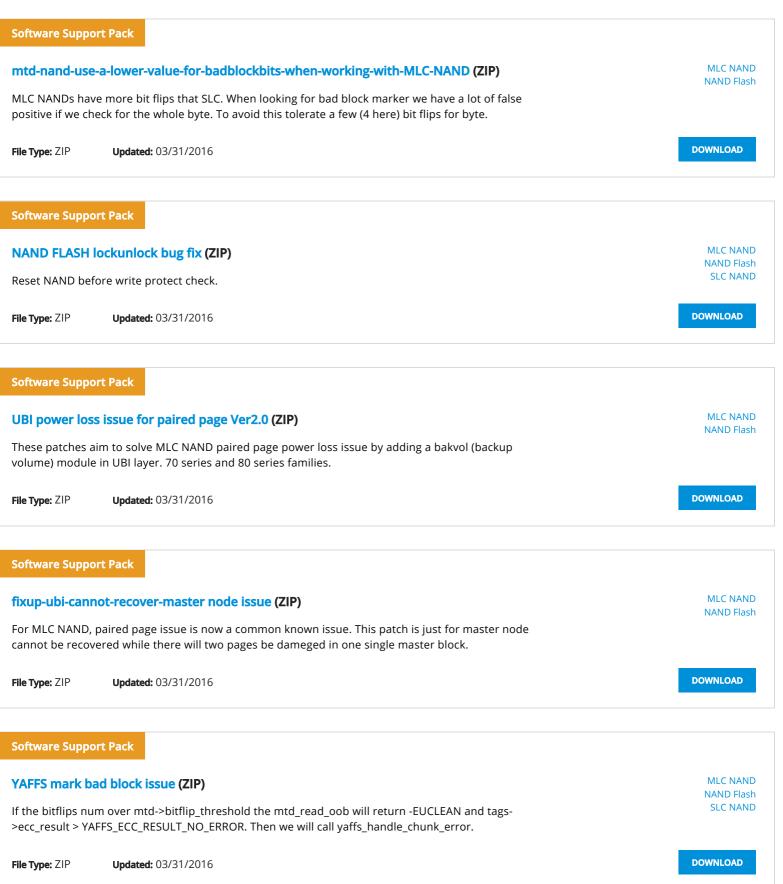
Orderable Parts for: MT29F8G08MAAWC-ET SEE ALL MLC NAND PARTS FBGA SPD Chipset Start Status Media PLP **Alternative Part** Validation Date Code Data MT29F8G08MAAWC-Obsolete N/A N/A N/A N/A N/A No ET:B

Detailed Specifications

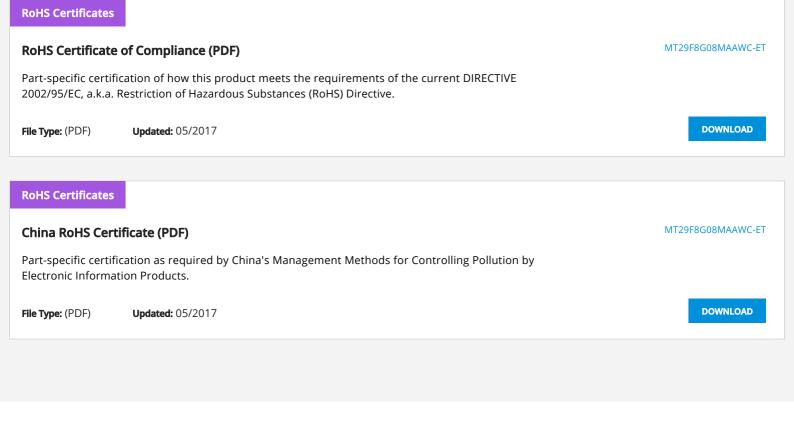
Density	8Gb	Status	Obsolete	NAND Type	2D	RoHS	Yes
Width	x8	Voltage	3.3V	Package	TSOP	Pin Count	48-pin
Op. Temp.	-40C to +85C	MT/s		I/O	Common	Product Name	

Sim Models & Software

Software



RoHS Certificates



Documentation & Support

See All MLC NAND Documentation

Technical Notes

SEARCH (4) MLC NAND TECHNICAL NOTES

Technical Notes

TN-00-33: Power Integrity Simulation with IBIS 5.0 Models (PDF)

(TN-00-33) This technical note describes the new features in IBIS 5.0 enabling PI simulation. It also provides an overview of some of the modeling accuracy challenges and compares SSO simulation results using various electronic design automation (EDA) software tools.

File Type: PDF Updated: 01/25/2016

Technical Notes

TN-00-01: Moisture Sensitivity of Plastic Packages (PDF)

(TN-00-01) This technical note describes shipping procedures for preventing memory devices from absorbing moisture and recommendations for baking devices exposed to excessive moisture.

File Type: PDF Updated: 02/14/2013

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Technical Notes		
TN-29-65: Softw (PDF)	are Device Drivers for Very Large Page Micron NAND Flash Memory	MLC NAND NAND Flash SLC NAND
(TN-29-65) Downlo	oad the low-level driver described in this document here.	
File Type: PDF	Updated: 10/15/2010	DOWNLOAD
Technical Notes		
TN-29-61: Wear	Leveling in NAND Flash Memory (PDF)	MLC NAND NAND Flash SLC NAND
	chnical note describes the recommended wear leveling algorithm to be ne FTL software for NAND Flash memory.	
File Type: PDF	Updated: 10/15/2010	DOWNLOAD

SEARCH (4) MLC NAND TECHNICAL NOTES

Parts with the same Data Sheet (6)

MT29F8G08MAAWC-ET (Current)		MT29F16G08QAAWC	MT29F16G08QAAWC-ET	MT29F32G08TAAWC		
Status	Obsolete	Obsolete	Obsolete	Obsolete		
Density	8Gb	16Gb	16Gb	32Gb		
NAND Type	2D	2D	2D	2D		
RoHS	Yes	Yes	Yes	Yes		
Width	x8	x8	x8	x8		
Voltage	3.3V	3.3V 3.3V		3.3V		
Package	TSOP	TSOP	TSOP	TSOP		
Pin Count	48-pin	48-pin	48-pin	48-pin		
Op. Temp.	-40C to +85C	0C to +70C	-40C to +85C	0C to +70C		
	MT/s					
I/O	Common	Common	Common	Common		
Pr	oduct Name					

MT29F8G08MAAWC-ET (Current)									
Status	Obsolete		Whore to Run						
Density	8Gb		Where to Buy						
NAND Type	2D								
RoHS	Yes	atus	Media	FBGA Code	SPD Data	Chipset Validation	PLP	Start Date	Alternative Part
Width	x8								
Voltage	3.3V	solete	N/A	N/A	N/A	N/A	No		N/A
Package	TSOP								
Pin Count	48-pin								
Op. Temp.	-40C to +85C		- OR - Check with Distributors						
MT/s			Your Region: Americas 💌						
I/O	Common								
Pi									
					VIEW				

See All Distributors

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